

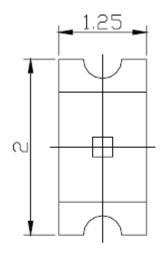
APPROVAL SHEET

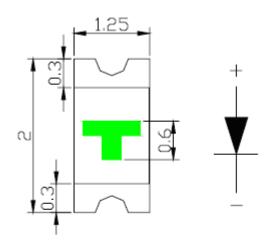
CUSTOMER:				
CUSTOMER PART NO.				_
TYPE NO.: <u>N0G10</u>	S40			
PACKAGE SIZE: 2.0	x 1.25 x 0.8mm SMD	LED		_
DICE MATERIAL:	InGaN	PEAK WAVE LENGTH(nm)	525	_
EMITTED COLOR:_	Ultra Green	VIEWING ANGLE (deg):	130	-
EPOXY COLOR:	Water Clear	IV(mcd):600		

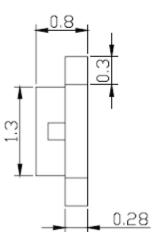
ELECTRICAL PARAMETER	SYMBOL	MIN	TYP	MAX	AT Ta = 25 UNIT	TEST
Luminous	STNIDOL	IVIIIV	1 1 1	WIAA	UNII	11251
Intensity	IV	400	600	1000	mcd	
Viewing Angle	2⊖1/2		130		deg	
Peak Emission Wavelength	λр		525		nm	IF = 20mA
Dominant Wavelength	λр	520	526	532	nm	IF = 20InA
Spectral Line Half-Width	Δλ		36		nm	
Forward Voltage	VF	2.8	3.2	3.4	V	
Power Dissipation	Pd			85	mW	
Peak Forward Current (Duty1/10 @ 1KHZ)	IF (Peak)			100	mA	
Recommended Operating Current	IF (Rec)		20		mA	
● ABSOLUTE MAXIMUM RATINGS : (Ta = 25°c)						
Reverse Voltage			:	5 Volt		
Reverse Current : 10 uA (VR=5V)			(V)			
Electrostatics Discharge (ESD) : 200 Volt						
Operating Temperature Range : -40°C TO 85°C						
Storage Temperature Range : -40°C TO 100°C						
Lead Soldering Temperature Range						
【1.6 mm (1/16 inch) from body】 : 260°C For 5 Seconds						

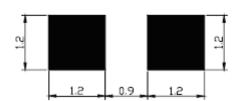
SMD LED PACKAGE DIMENSIONS

Package Outline Dimensions:







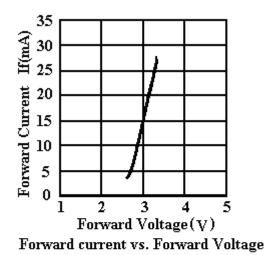


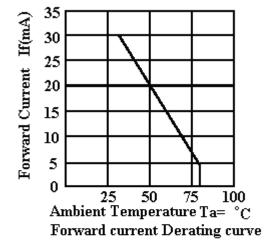
Recommended soldering pad design

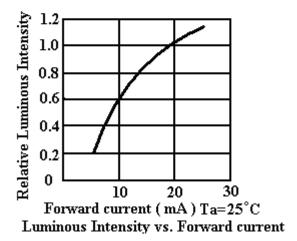
DEVICE NO.:N0G10S40	DRAWING NO.	ENGINEER
ALL TOLERANCE SHALL BE	DRAWING DATE	APPROVER
±0.008 inch/0.2mm		
UNLESS OTHERWISE NOTED		

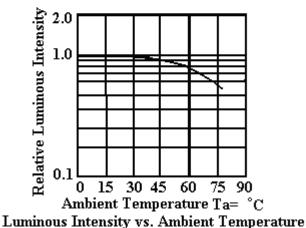
Typical Electro-Optical Characteristics Curves

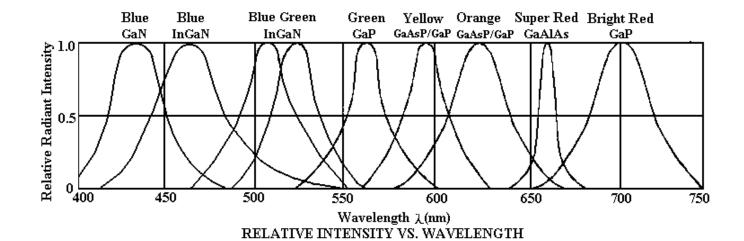
Ultra Green (InGaN $\lambda P = 525$ nm)











Reliability test For LED Lamps

Type No.: N0G10S40

NO.	Item	Test Conditions	Test Time/ Cycle	Sample Size	Ac/Re
1	DC Operating Life	Temperature:25°C IF:20mA	1000HRS	20PCS	0/1
2	High Temperature High Humidity	Temperature:85°ℂ 85%RH	1000HRS	20PCS	0/1
3	High Temperature Storage	Temperature:100°C	1000HRS	20PCS	0/1
4	Low Temperature Storage	Temperature: −40°C	1000HRS	20PCS	0/1
5	Temperature Cycling	85°C ~ 25°C ~ − 35°C 15min~ 5min~ 15min	15Cycles	20PCS	0/1
6	Thermal Shock	85°C ~ 25°C ~ − 10°C 5min~ 10sec ~ 5min	15Cycles	20PCS	0/1
7	Solder Heat	Temperature:260°C±5°C	10SEC.	20PCS	0/1

♦ Luminous Intensity BIN Limits

Test condition: @ 20 mA				
BIN Code	I _{Vmin} (mcd)	I _{Vmax} (mcd)		
F	400	500		
G	500	600		
H	600	800		
I	800	1000		

Tolerance for each Bin limit is $\pm 15\%$.

♦ Dominant Wavelength BIN Limits

Test condition: @ 20 mA				
BIN Code	λ _{Dmin} (nm)	λ _{Dmax} (nm)		
H	520	523		
I	523	526		
J	526	529		
K	529	532		

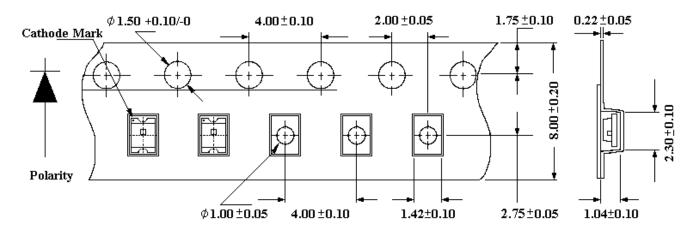
Tolerance for each Bin limit is ± 1 nm.

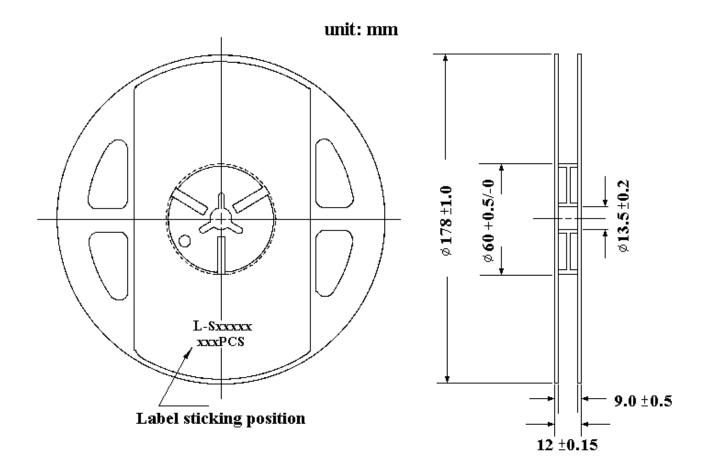
♦ Forward Voltage BIN Limits

Test condition: @ 20 mA				
BIN Code	V _{Fmin} (v)	$V_{Fmax}(v)$		
Q	2.8	3.0		
R	3.0	3.2		
S	3.2	3.4		

Tolerance for each Bin limit is ± 0.05 V.

Carrier Tape Dimensions: Loaded quantity 4000PCS per reel

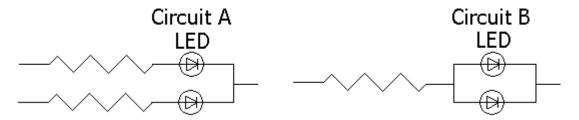




Precautions For Use LED

1. Drive Method

LED is current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in a application, it is recommended that a current limiting resistor be incorporated in the drive circuit.



- (a) Circuit A it is recommended circuit.
- (b) Circuit B the brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

2. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change(Burn out will happen).

3. Storage

The Storage Temperature and RH are: 5° C ~ 30° C, RH 60% or less.

Once the package is opened, the products should be used with in a week. Otherwise,

they should be kept in moisture proof package with moisture absorbent material (silica gel).

we suggest our customers to use our products within a year.

If the moisture absorbent material (silica gel) has faded away or the LEDs exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: more than 24 hours at 60° C $\pm 5^{\circ}$ C.

4. Electrostatic Discharge (ESD)

Static electricity or surge voltage will damage the LEDs

Suggestions to prevent ESD damage:

Use of a conductive wrist band or ante-electrostatic glove when handing these LEDs

All devices, equipment, and machinery must be properly grounded.

Work tables storage racks, etc. should be properly grounded

In the events of manual working in process, make sure the devices are well protected from ESD at any time.

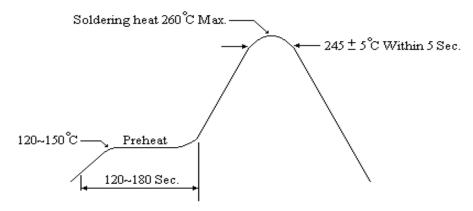
5. Others

- (a) If want to have the uniform luminance and color, please use the same binning number, and avoid using intermix to cause the differences of luminance and color.
- (b) The appearance and specifications of the product may be modified for improvement without prior notice.

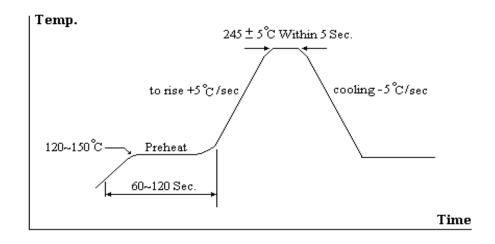
6. Soldering

Recommended soldering condition as shown below:

Soldering heat (DIP)



Reflow Temp./Time



Soldering Iron

Temperature at tip of iron: 300°C Max. (25 W Max.)

Soldering Time : 3 sec. \pm 1 sec.(one time only)

If temperature is higher, time should be shorter